

800V N-Channel MOSFET

FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information			
Device Package		Marking	
CS7N80F	TO-220F	CS7N80F	
CS7N80P	TO-220	CS7N80P	

TO-220F GDS	TO-220 GDS
	Go

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted					
Parameter	Symbol	Vá	Unit		
Farameter		TO-220F	TO-220	Unit	
Drain-Source Voltage ($V_{GS} = 0V$)	V _{DSS}	800		V	
Continuous Drain Current	I _D	7		А	
Pulsed Drain Current (note1)	I _{DM}	28		А	
Gate-Source Voltage	V _{GSS}	±	30	V	
Single Pulse Avalanche Energy (note2)	E _{AS}	245		mJ	
Avalanche Current (note1)	I _{AS}	7		А	
Repetitive Avalanche Energy (note1)	E _{AR}	147		mJ	
Power Dissipation ($T_c = 25^{\circ}C$)	P _D	25	70	W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55-	-+150	°C	

Thermal Resistance				
Parameter	Symbol	Va	Unit	
		TO-220F	TO-220	- Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	5	1.78	K/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60	



CS7N80F, CS7N80P

			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	800			V	
Zero Gate Voltage Drain Current	1	$V_{DS} = 800V, V_{GS} = 0V, T_{J} = 25^{\circ}C$	-		1		
Zero Gale voltage Drain Gurrent	I _{DSS}	$V_{DS} = 640V, V_{GS} = 0V, T_{J} = 125^{\circ}C$	-		100	μA	
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 30V$			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.0		4.0	V	
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 3.5A$		1.35	1.6	Ω	
Dynamic							
Input Capacitance	C _{iss}			1178			
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$		128		pF	
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		27			
Total Gate Charge	Q_{g}			49			
Gate-Source Charge	Q_gs	$V_{DD} = 640V, I_D = 7A, V_{GS} = 10V$		6		nC	
Gate-Drain Charge	Q_{gd}			26			
Turn-on Delay Time	t _{d(on)}			43			
Turn-on Rise Time	t _r	V _{DD} = 400V, I _D = 7A,		28			
Turn-off Delay Time	t _{d(off)}	$R_{G} = 25 \Omega$		244		ns	
Turn-off Fall Time	t _f			54			
Drain-Source Body Diode Character	istics						
Continuous Body Diode Current	۱ _s	T 0500			7	۸	
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			28	A	
Body Diode Voltage	V_{SD}	$T_J = 25^{o}C, I_{SD} = 3.5A, V_{GS} = 0V$			1.4	V	
Reverse Recovery Time	t _{rr}	V _{GS} = 0V,I _S = 7A,		295		ns	
Reverse Recovery Charge	Q _{rr}	di _F /dt =100A /µs		1.7		μC	

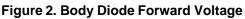
Notes

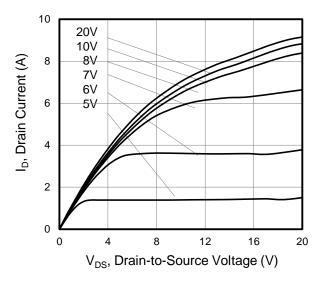
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 °C
- 3. Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%



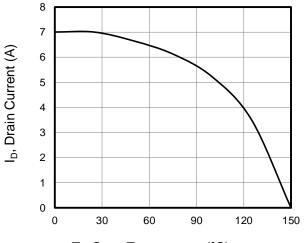
Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)

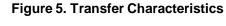


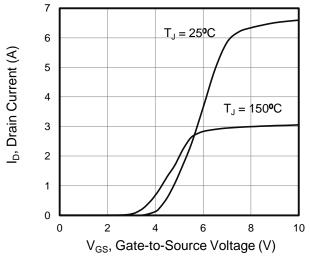






T_J, Case Temperature (^oC)





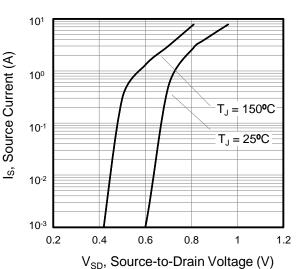


Figure 4. BV_{DSS} Variation vs. Temperature

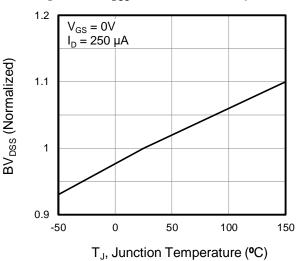
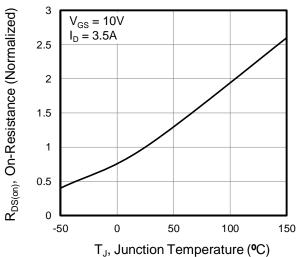
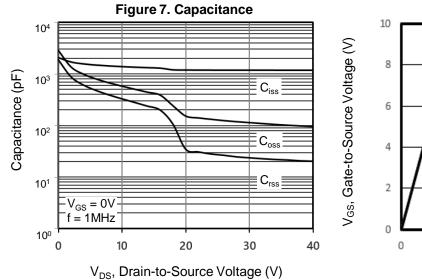


Figure 6. On-Resistance vs. Temperature

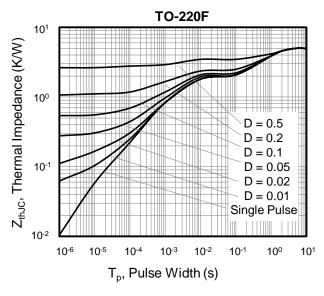




Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted







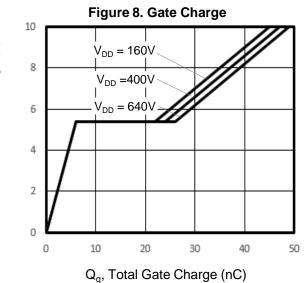
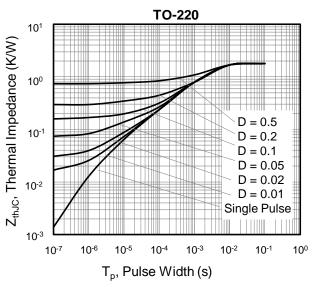


Figure 10. Transient Thermal Impedance







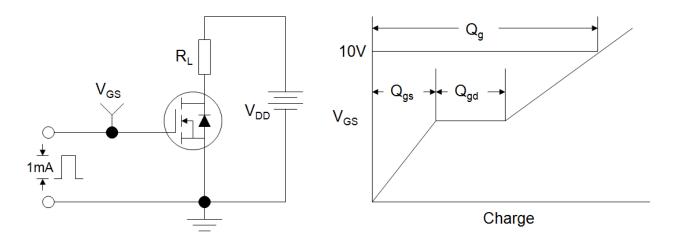


Figure B: Resistive Switching Test Circuit and Waveform

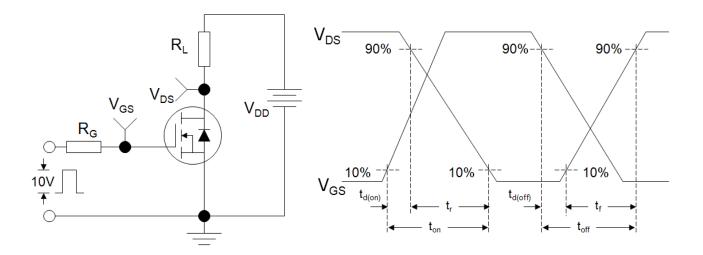
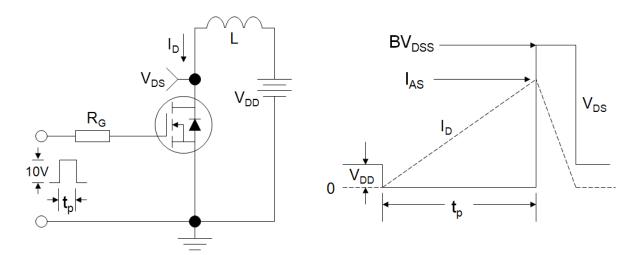


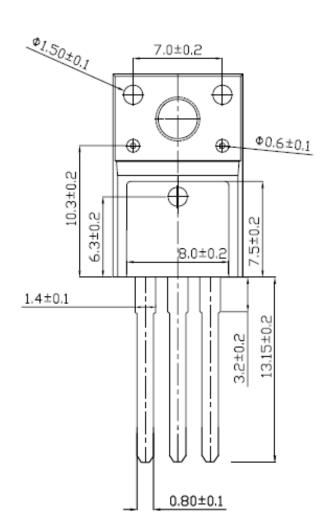
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

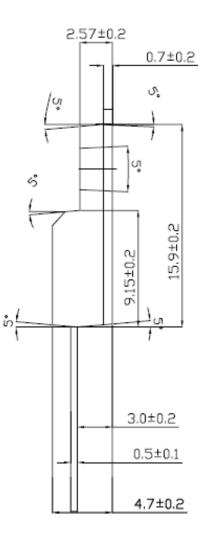






TO-220F

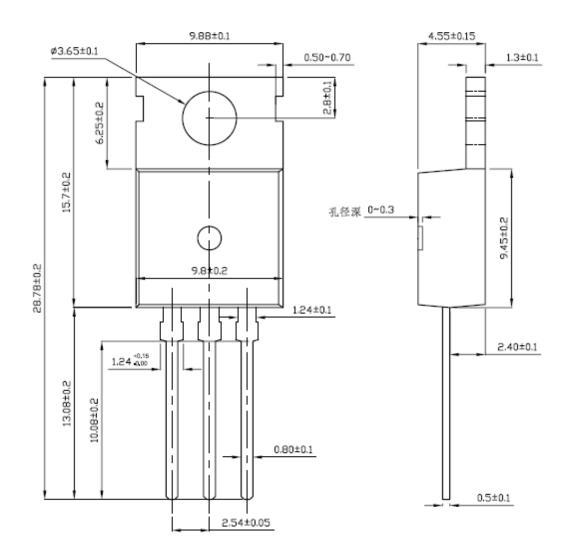








TO-220





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